

Attorney Docket No. TI-19646

DEPARTMMENT OF COMMERCE HONORABLE COMMISSIONER OF PATENTS AND TRADEMARKS Washington, DC 20231

Sir:

"EXPRESS MAIL" mailing label number TB309674057,

Date of Deposit: 3-/7-95. I hereby certify that the accompanying Application is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Patricia J. Jones

Transmitted herewith for filing is the patent application of:

Inventor(s): Richard M. Weber and Kerrin A. Rummel

For: "Construction of Phase Change Material Embedded Electronic Circuit Boards and Electronic Circuit Board Assemblies using Porous and Fibrous Media"

Enclosed is (are):

sheet(s) of formal drawings.

FEE CALCULATION					FEE	
	ACTUAL	ALLOWED	NUMBER EXTRA	RATE		IC FEE 30.00
Total Claims	20	- 20 =	0	x \$22 =	\$	00.00
Independent Claims	01	- 03 =	0	x \$76 =	\$	00.00
	•		Total F	Filing Fee	\$	730.00

Please charge Deposit Account No. 20-0668 in the amount of the Total Fees set forth. The commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Account No. 20-0668. This form is submitted in triplicate.

All correspondence related to this application may be addressed to the undersigned at Texas Instruments Incorporated, M/S 219, P.O. Box 655474, Dallas, TX, 75265.

Rene' E. Grossman

Registration No. 22,656

Date